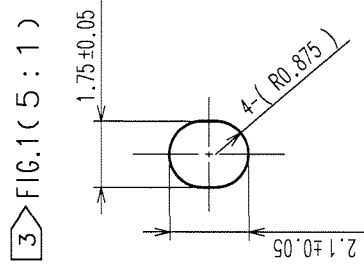
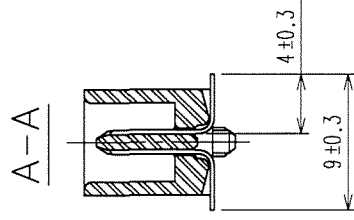
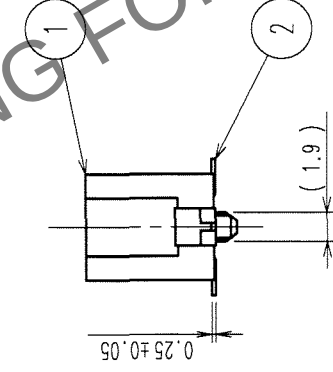
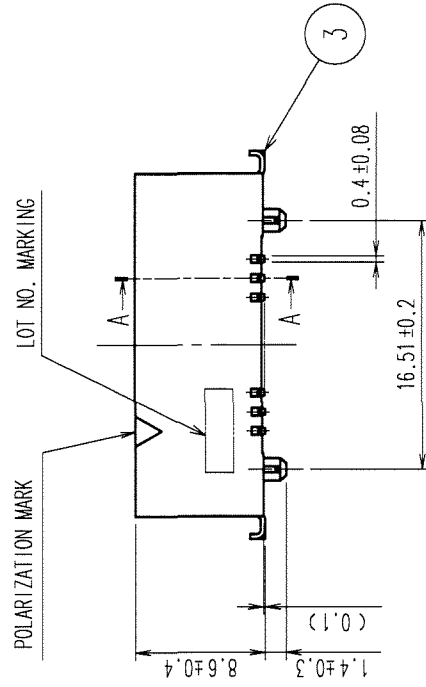
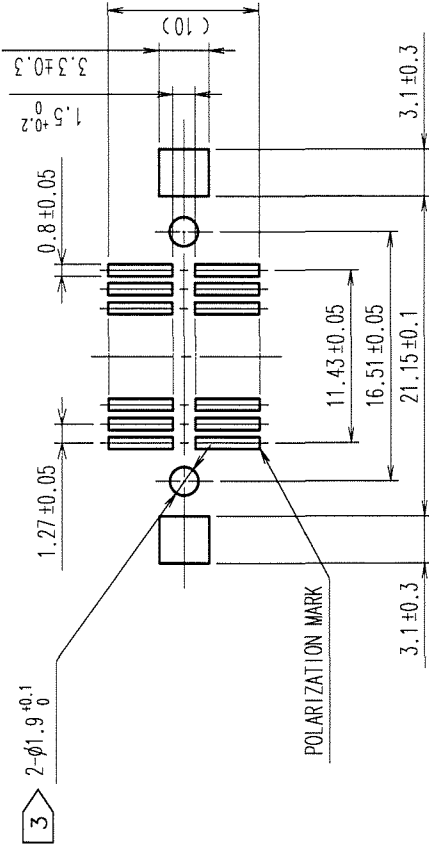
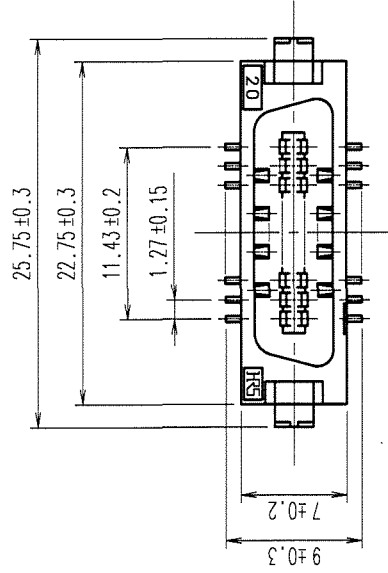


		DESCRIPTION OF REVISIONS		BY	CHKD	DATE	COUNT	DESCRIPTION OF REVISIONS	BY	CHKD	DATE
	△					.	△				.
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RECOMMENDED LAND PATTERN DIMENSION OF PCB (MOUNTING SIDE)



NOTES

- 1 LEAD CO-PLANARITY SHALL BE 0.15 MAX.
- 2 THE DIMENSIONS IN PARENTHESES ARE FOR REFERENCE.
- 3 IN CASE OF THE AUTOMATED MOUNTING, RECOMMENDED HOLE DIAMETER OF BOSS IS SHOWN IN FIG.1.

3	BRASS	TIN-PLATING	2	PHOSPHOR BRONZE	CONTACT AREA: GOLD 0.2μm min.
1	PPS	LIGHT BROWN (UL94V-0)			LEAD AREA: TIN-PLATING 2μm min.
NO.	MATERIAL	FINISH, REMARKS	NO.	MATERIAL	UNDER PLATING: NICKEL 2μm min.
CODE NO. (OLD)		DRAWING NO. EDC3-082752-21	PART NO. FX2-20P-1.27SVL (71)		
CL					
DRAWN A. SUZUKAWA 06.02.08		DESIGNED H. Nakamura 06.02.13		CHECKED H. Nakamura 06.02.13	APPROVED H. Nakamura 06.02.13
FINISH, REMARKS		FINISH, REMARKS			
HRS		HIROSE ELECTRIC CO., LTD		CL572-2051-7-71	
UNITS		SCALE 2 : 1		CODE NO.	
mm		DRAWING NO.		1 / 1	

TO	PCK			
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